

5V and 3.3V Supply Monitor, Watchdog Timer, Manual Reset, with Active High & Low Resets



FEATURES

- Selectable reset voltage tolerance
 - CAT1232LP for 5V supply
 - CAT1832 for 3.3V supply
- Selectable watchdog period: 150ms, 600ms or 1.2 sec
- Two reset outputs
 - Active high, push-pull reset output
 - Active low, open-drain reset output (CAT1232LP)
 - Active low, push-pull reset output (CAT1832)
- Debounced manual push-button reset
- **Compact SOIC and MSOP packages**

APPLICATIONS

- **■** Microprocessor Systems
- **■** Portable Equipment
- Controllers
- Single Board Computers
- **■** Instrumentations
- **■** Telecommunications

For Ordering Information details, see page 11.

DESCRIPTION

The CAT1232LP and CAT1832 microprocessor supervisors can halt and restart a "hung-up" or "stalled" microprocessor, restart a microprocessor after a power failure, and debounce a manual/push-button microprocessor reset switch. The devices are drop in replacements for the Maxim/Dallas Semiconductor DS1232LP and DS1832 supervisors

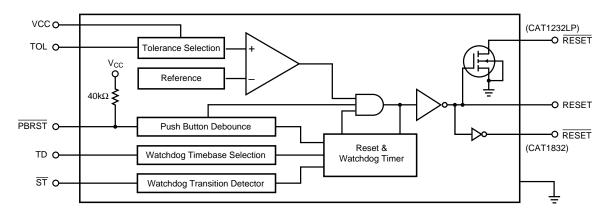
Precision reference and comparator circuits monitor the 5V or 3.3V system power supply voltage, V_{CC}. During power-up or when the power supply falls outside selectable tolerance limits, both the RESET and RESET become active. After the power supply voltage rises above the RESET threshold voltage, the reset signals remain active for a minimum of 250ms, allowing the power supply and system processor to stabilize. The trip-point tolerance input, TOL, selects the trip level tolerance to be either 5% or 10% for the CAT1232LP 5V supply and 10% or 20% for the CAT1832 3.3V supply.

Each device has a push-pull, active HIGH reset output. The CAT1232LP also has an open drain, active LOW reset output while the CAT1832 also has a push-pull, active LOW reset output.

A debounced manual reset input activates the reset outputs and holds them active for a minimum period of 250ms after being released.

Also included is a watchdog timer to reset a microprocessor that has stopped due to a software or hardware failure. Three watchdog time-out periods are selectable: 150ms, 600ms and 1.2sec. If the ST input is not strobed low before the watchdog time out period expires, the reset signals become active for a minimum of 250ms.

FUNCTIONAL DIAGRAM





PIN CONFIGURATION

8-Lead SOIC/MSOP/DIP

PBRST 1	8 V _{CC}
TD 2	7 ST
TOL 3	6 RESET
GND 4	5 RESET

16-Lead SOIC NC 1 16 NC 15 V_{CC} PBRST 2 NC 3 14 NC 13 ST TD 4 NC 5 12 NC TOL 6 11 RESET NC 7 10 NC 9 RESET GND 8

PIN DESCRIPTION

Pin Number 8-Lead Package	Pin Number 16-Lead Package	Name	Function
1	2	PBRST	Debounced manual pushbutton reset input
2	4	TD	Watchdog typical time delay selection: a) t_{TD} = 150ms for TD = GND b) t_{TD} = 600ms for TD = Open c) t_{TD} = 1200ms for TD = V_{CC}
3	6	TOL	CAT1232LP TOL selects 5% (TOL = GND) or 10% (TOL = V_{CC}) trip point tolerance. CAT1832 TOL selects 10% (TOL = GND) or 20% TOL = V_{CC}) trip point tolerance.
4	8	GND	Ground
5	9	RESET	Active HIGH reset output. RESET is active 1. If V _{CC} falls below the reset voltage trip point 2. If PBRST is low 3. If ST is not strobed low before the timeout period set by TD expires. 4. During power-up.
6	11	RESET	Active LOW reset output. (See RESET)
7	13	ST	Strobe Input
8	15	Vcc	Power Supply
	1, 3. 5, 7, 10, 12, 14, 16	NC	No internal connection



ABSOLUTE MAXIMUM RATINGS*

Voltage on V _{CC} 0.5V	to 7.0V	Maximum Junction Temperature	125°C
Voltage on $\overline{\text{ST}}$ and TD0.5V to V_{C0}	c + 0.5V	Storage Temperature Range65°C	to +150°C
oltage on PBRST, RESET and RESET0.5V to V _{CC}	o + 0 5\/	Lead Soldering Temperature (10 sec)	300°C
and NEGET0.3V to V(() + 0.3V		Operating Temperature Range40°C	C to +85°C

ELECTRICAL CHARACTERISTICS

Unless otherwise stated, $1.0V \le V_{CC} \le 5.5V$ and over the operating temperature range of -40°C to +85°C. All voltages are referenced to ground.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Vcc	Supply Voltage		1.0		5.5	V
1	Supply Current	V _{CC} = 5.5V, CAT1232LP		35	50	
I _{CC1}	Supply Current	V _{CC} = 3.6V, CAT1832		20	35	μΑ
\/	CT and DDDCT lamest likely laws	(5)	2		V 0 2V	V
V_{IH}	ST and PBRST Input High Level	(6)	V _{CC} - 0.4V		V _{CC} + 0.3V	V
	OT and DDDOT laws to a second	V _{CC} = 5.5V, CAT1232LP	- 0.3		0.8	V
V_{IL}	ST and PBRST Input Low Level	V _{CC} = 3.6V, CAT1832			0.5	V
Vсстр	V _{CC} Trip Point (TOL = GND)	CAT1232LP	4.50	4.62	4.74	V
V _{CCTP}	V _{CC} Trip Point (TOL = V _{CC})	CAT1232LP	4.25	4.37	4.49	V
Vсстр	V _{CC} Trip Point (TOL = GND)	CAT1832	2.80	2.88	2.97	V
VCCTP	V _{CC} Trip Point (TOL = V _{CC})	CAT1832	2.47	2.55	2.64	V
t _{TD}	Watchdog Time-Out Period	TD = GND	62.5	150	250	ms
t _{TD}	Watchdog Time-Out Period	TD = Vcc	500	1200	2000	ms
t _{TD}	Watchdog Time-Out Period	TD floating	250	600	1000	ms
V _{OH}	Output Voltage	$I = -500 \mu A^{(3)}$	V _{CC} - 0.5V	V _{CC} - 0.1V		V
I _{OH}	Output Current	Output = 2.4V ⁽²⁾		- 350		μΑ
I _{OL}	Output Current	Output = 0.4V,	10			mA
Ι _Ι	Input Leakage	(1)	- 1.0		1.0	μΑ
R _{PU}	Internal Pull-Up Resistor	(1)	32	40	55	kΩ
CIN	Input Capacitance				5	pF
C _{OUT}	Output Capacitance				7	pF
t _{PB}	PBRST Manual Reset Minimum Low Time	PBRST = V _{IL}	20			ms
t _{RST}	Reset Active Time		250	600	1000	ms
t _{ST}	ST Pulse Width	(4)	20			ns
t _{RPD}	V _{CC} Fail Detect to RESET or RESET			5	8	μs
tF	V _{CC} Slew Rate		20			μs
tpDLY	PBRST Stable LOW to RESET and RESET Active				20	ms
t _{RPU}	V _{CC} Detect to RESET or RESET Inactive	trise = 5µs	250	600	1000	ms
t _R	V _{CC} Slew Rate	4.25V to 4.75V	0			ns

⁽¹⁾ PBRST is internally pulled HIGH to V_{CC} through a nominal $40k\Omega$ resistor (R_{PU}).

⁽²⁾ RESET is an open drain output on the CAT1232LP.

⁽³⁾ RESET remains within 0.5V of V_{CC} on power-down until V_{CC} falls below 2V. RESET remains within 0.5V of ground on power-down until V_{CC} falls below 2.0V.

⁽⁴⁾ Must not exceed the minimum watchdog time-out period (t_{TD}). The watchdog circuit cannot be disabled. To avoid a reset, ST must be strobed.

⁽⁵⁾ Measured with $V_{CC} \ge 2.7V$.

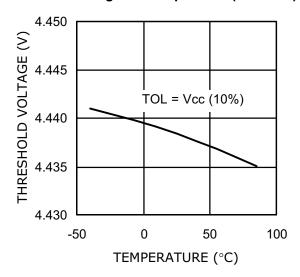
⁽⁶⁾ Measured with V_{CC} < 2.7V.



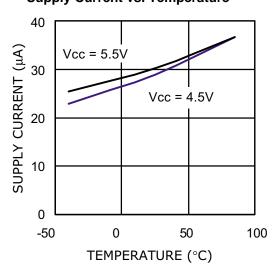
TYPICAL CHARACTERISTICS

For the CAT1232LP, V_{CC} = 5V and T_{AMB} = 25°C unless otherwise stated.

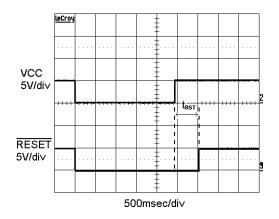
Threshold Voltage vs. Temperature (10% TOL)



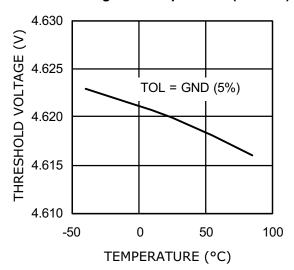
Supply Current vs. Temperature



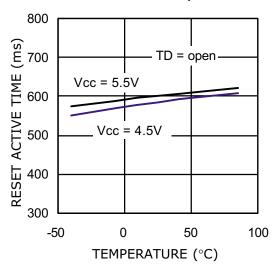
Reset Active Time Waveform



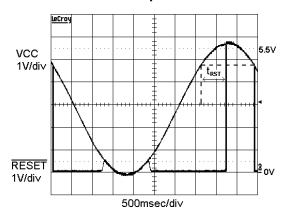
Threshold Voltage vs. Temperature (5% TOL)



Reset Active Time vs. Temperature



Transient Response





RESET.

APPLICATION INFORMATION

SUPPLY VOLTAGE MONITOR

Reset Signal Polarity and Output Stage Structure RESET is an active LOW signal. It is developed with an open drain driver in the CAT1232LP. A pull-up resistor is required, typical values are $10k\Omega$ to $50k\Omega$. The CAT1832 uses a CMOS push-pull output stage for the

RESET is an active High signal developed by a CMOS push-pull output stage and is the logical opposite to RESET.

Trip Point Tolerance Selection

The TOL input is used to select the V_{CC} trip point threshold. This selection is made connecting the TOL input to ground or V_{CC} . Connecting TOL to Ground makes the V_{CC} trip threshold 4.62V for the CAT1232LP and 2.88V for the CAT1832.

4.37V for the CAT1232LP and 2.55V for the CAT1832.

After Vcc has risen above the trip point set by TOL,

Connecting TOL to VCC makes the VCC trip threshold

After V_{CC} has risen above the trip point set by TOL, RESET and RESET remain active for a minimum time period of 250ms.

On power-down, once V_{CC} falls below the reset threshold the RESET outputs will remain active and are guaranteed valid down to a V_{CC} level of 1.0V.

Tolerance Select	Trip Point	Trip	Point Voltage	: (V)
Voltage	Tolerance	MIN	NOMINAL	MAX
CAT1232LP TOL = V _∞	10 %	4.25	4.37	4.49
CAT1232LP TOL = GND	5 %	4.50	4.62	4.74
CAT1832 TOL = V _☉	20 %	2.47	2.55	2.64
CAT1832 TOL = GND	10 %	2.80	2.88	2.97

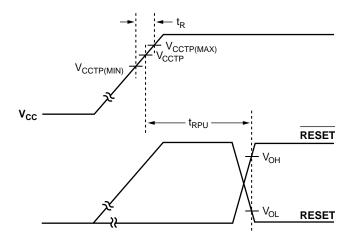


Figure 1. Timing Diagram: Power Up

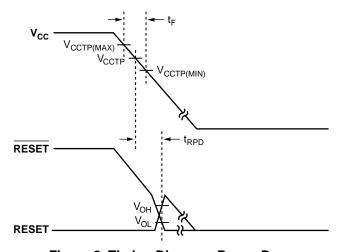


Figure 2. Timing Diagram: Power Down

Manual Reset Operation

Push-button input, \overline{PBRST} , allows the user to issue reset signals. The pushbutton input is debounced and is pulled high through an internal $40k\Omega$ resistor.

When PBRST is held low for the minimum time of 20 ms, both resets become active and remain active for a minimum time period of 250ms after PBRST returns high.

No external pull-up resistor is required, since \overline{PBRST} is pulled high by an internal 40k Ω resistor.

PBRST can be driven from a TTL or CMOS logic line or short-ed to ground with a mechanical switch.



WATCHDOG TIMER AND ST INPUT

A watchdog timer stops and restarts a microprocessor that has stopped proper operation or become "hung". The watchdog performs this function by monitoring the ST input. After the reset outputs go inactive the ST input must be strobed with a high-to-low signal transition prior to the minimum watchdog timeout period. However if the ST input is not strobed with a high-to-low signal transition prior to a watchdog timeout the reset outputs will become active for T_{RST} reseting and restarting the microprocessor. Once the resets return to the inactive state the watchdog timer restarts the process.

The TD input allows the user to select from three predetermined watchdog timeout periods. Always use the minimum timeout period to determine the required frequency of \overline{ST} high-to-low transitions and the maximum to determine the time prior to the reset outputs becoming active. \overline{ST} pulse widths must be 20ns or greater.

The watchdog timer cannot be disabled. It must be strobed with a high-to-low signal transition to avoid a watchdog timeout and subsequent reset.

TD Voltage	Watchdog Time-out Period (ms)			
Level	MIN	NOMINAL	MAX	
GND	62.5	150	250	
Floating	250	600	1000	
Vœ	500	1200	2000	

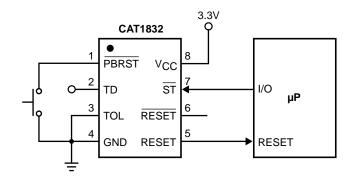


Figure 4. CAT1832 Application Circuit:
Pushbutton Reset

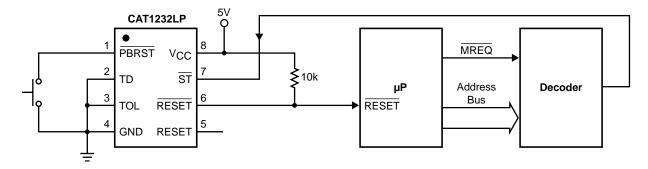


Figure 5. CAT1232LP Application Circuit: Watchdog Timer

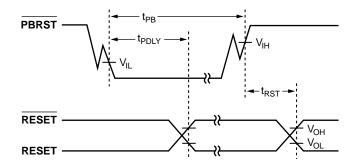
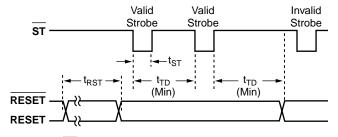


Figure 6. Timing Diagram: Pushbutton Reset

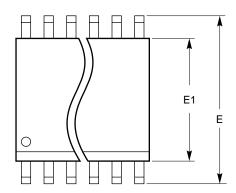


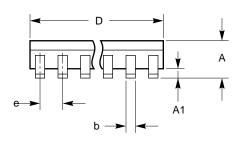
Note: ST is ignored whenever a reset is active.

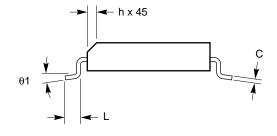
Figure 7. Timing Diagram: Strobe Input



PACKAGE DRAWING 16-LEAD WIDE BODY SOIC (300mil)







SYMBOL	MIN	NOM	MAX
A1	0.10		0.30
Α	2.36	2.49	2.65
b	0.33	0.41	0.51
С	0.23	0.28	0.32
D	10.10	10.31	10.50
Е	10.00	10.31	10.65
E1	7.40	7.50	7.60
е		1.27 BSC	
h	0.25		0.75
L	0.40	0.81	1.27
θ1	0°		8°

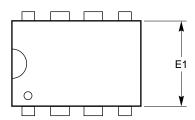
16-Lead_SOIC_(300mil).eps

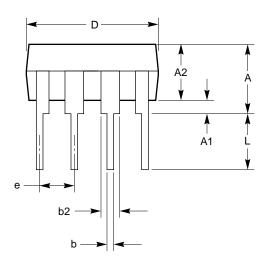
For current Tape and Reel information, download the PDF file from: http://www.catsemi.com/documents/tapeandreel.pdf.

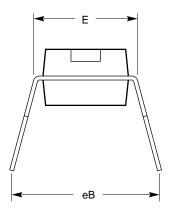
- 1. All dimensions are in millimeters.
- 2. Complies with JEDEC specification MS-013.



PACKAGE DRAWING 8-LEAD DIP (300mil)







SYMBOL	MIN	NOM	MAX
Α			4.57
A1	0.38		
A2	3.05		3.81
b	0.36	0.46	0.56
b2	1.14		1.52
D	9.02		10.16
E	7.62	7.87	8.26
E1	6.17	6.35	7.49
е		2.54 BSC	
eB	7.87		9.65
L	2.79		3.81

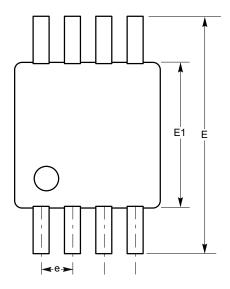
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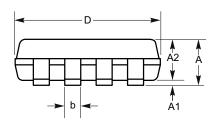
For current Tape and Reel information, download the PDF file from: http://www.catsemi.com/documents/tapeandreel.pdf.

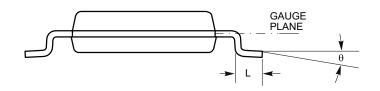
- 1. All dimensions are in millimeters.
- 2. Complies with JEDEC Standard MS001.
- 3. Dimensioning and tolerancing per ANSI Y14.5M-1982



PACKAGE DRAWING 8-LEAD MSOP







SYMBOL	MIN	NOM	MAX
Α			1.10
A1	0.00		0.15
A2	0.75		0.95
b	0.22		0.38
D	2.90	3.00	3.10
Е	4.80	4.90	5.00
E1	2.90	3.00	3.10
е		0.65 BSC	
L	0.40		0.8
θ	0°		8°

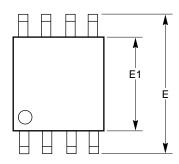
8-lead_MSOP3.eps

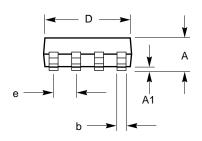
For current Tape and Reel information, download the PDF file from: http://www.catsemi.com/documents/tapeandreel.pdf.

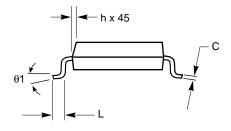
- 1. All dimensions are in millimeters. Angles in degrees.
- 2. Complies with JEDEC Specification MO-187.
- 3. Stand off height/coplanarity are considered as special characteristics.



PACKAGE MECHANICAL 8-LEAD Narrow Body SOIC (150mil)







SYMBOL	MIN	NOM	MAX
A1	0.10		0.25
Α	1.35		1.75
b	0.33		0.51
С	0.19		0.25
D	4.80		5.00
E	5.80		6.20
E1	3.80		4.00
е		1.27 BSC	
h	0.25		0.50
L	0.40		1.27
θ1	0°		8°

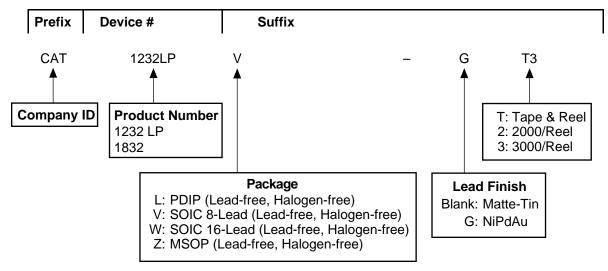
24C16_8-LEAD_SOIC.eps

For current Tape and Reel information, download the PDF file from: http://www.catsemi.com/documents/tapeandreel.pdf.

- 1. All dimensions are in millimeters. Angles in degrees.
- 2. Complies with JEDEC Specification MS-012.



SAMPLE OF ORDERING INFORMATION



- (1) All packages are RoHS-compliant (Lead-free, Halogen-free).
- (2) The standard lead finish is NiPdAu.
- (3) The device used in the above example is a CAT1232LPV-GT3 (SOIC, NiPdAu, Tape & Reel).
- (4) For additional package and temperature options, please contact your nearest Catalyst Semiconductor Sales office.

Green NiPdAu Lead Finish				
Ordering Part Number	Package	Parts per Tube	Parts Per Reel	Reel Size (inch)
CAT1232LPL-G	8-lead, DIP	50	_	_
CAT1232LPV-GT3	8-lead, SOIC	_	3,000	13
CAT1232LPZ-GT3	MSOP	_	3,000	13
CAT1232LPW-GT2	16-lead, SOIC	_	2,000	13
CAT1832L-G	8-lead, DIP	50	_	_
CAT1832V-GT3	8-lead, SOIC	_	3,000	13
CAT1832Z-GT3	MSOP	_	3,000	13

REVISION HISTORY

Date	Revision	Comments
06/13/2005	00	Initial Issue
07/26/2005	0A	Update Electrical Characteristics
		Add Typical Characteristics
03/27/2006	0B	Update Document Title Update Ordering Information
08/21/2006	0C	Add Ordering Information detail to page 1 Update Sample of Ordering Information

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